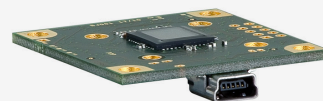
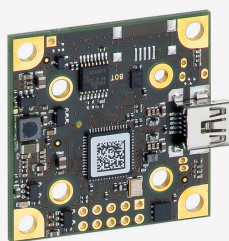
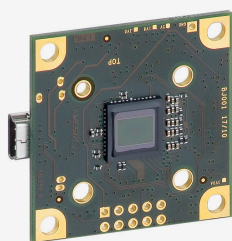


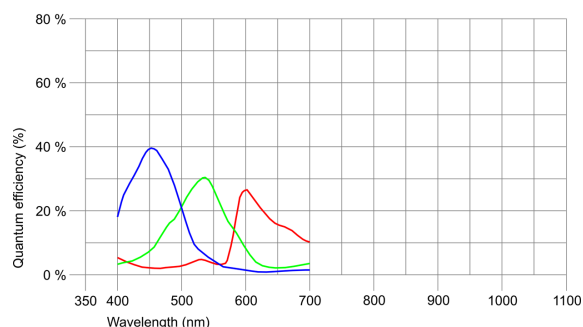
Discontinued
The model has been discontinued.



Specification

Sensor

Sensor type	CMOS Color
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	10 MP
Resolution	10.55 Mpix
Resolution (h x v)	3840 x 2748 Pixel
Aspect ratio	4:3
ADC	12 bit
Color depth (camera)	8 bit
Optical sensor class	1/2"
Optical Size	6.413 mm x 4.589 mm
Optical sensor diagonal	7.89 mm (1/2.03")
Pixel size	1.67 µm
CRA (Chief Ray Angle)	0 °
Manufacturer	Onsemi
Sensor Model	MT9J003STC
Gain (master/RGB)	8.5x/5.3x
AOI horizontal	increased frame rate
AOI vertical	increased frame rate
AOI image width / step width	448 / 4
AOI image height / step width	4 / 2
AOI position grid (horizontal/vertical)	4 / 2
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: addition / Vertical: addition
Binning factor	2 / 4
Decimation (subsampling) horizontal	increased frame rate
Decimation (subsampling) vertical	increased frame rate
Decimation (subsampling) method	Color
Decimation (subsampling) factor	2 / 4



Model

Pixel clock range	5 MHz - 36 MHz
Frame rate freerun mode	3.2 fps
Frame rate trigger (maximum)	3.2 fps
Exposure time (minimum - maximum)	0.34 ms - 14582 ms
Power consumption	0.5 W - 1.3 W
Image memory	-

Ambient conditions

For PCB versions, refer to the separate hints in the respective documentation.

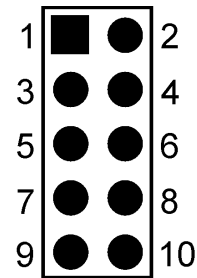
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	USB 2.0 mini-B
I/O connector	10-pin plated-through holes
Power supply	USB cable

Pin assignment I/O connector

1	USB Power supply (VCC) 5 V
2	USB Ground (GND)
3	Trigger input without optocoupler (+)
4	Flash output without optocoupler (+)
5	Power supply (internal voltage transformer), 3.3 V or 3.0 V (sensor-dependent)
6	USB Ground (GND)
7	General Purpose I/O (GPIO) 1
8	General Purpose I/O (GPIO) 2
9	I2C bus clock signal
10	I2C bus data signal



Design

Lens Mount	No mount
IP code	-
Dimensions H/W/L	36.0 mm x 36.0 mm x 5.7 mm
Mass	12 g
Housing material	-

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition	Freerun	✓
	Software trigger	-
	Hardware trigger	✓
	Trigger controlled exposure	-
	Denoiser	-
	Long exposure	-
	Line scan	-
	Global start	-

Flashing	Flashing	-
	PWM flashing	-
Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	-
On-board Image Processing	Pixel formats	
	Region of interest	✓
	Decimation (FPGA)	-
	Decimation (Sensor)	
	Binning (FPGA)	-
Others	Chunks	-
	Sequencer	-
	Firmware update	-
	1st supported firmware version	3.51